USB Type C

VBUS: 5-12V

USB320Li

TUSB221

BQ25895

TPS2514A

MSP430 G23 32

BQ29700

CSD25310*2

CSD83325L

TPS61235

5.1V/3A

3-4.5V

1S Battery

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Engineer:

Yingyang Ou

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Revision History

Revision

Notes

1.0

For Public Release

Version control disabled

SVN Rev:
PMP4496

Number:
Rev:

1.0

For Public Release

TID #:
PMP4496

Orderable:
N/A

USB-C DRP Power Bank With Fast Charger Input Reference Design

Project Title:

Designed for:

Public Release

Assembly Variant:

001

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USB-C DRP Power Bank With Fast Charger Input Reference Design

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Drawn By:

Engineer: Yingyang Ou

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Version control disabled

SVN Rev: PMP4496

Number: Rev: 1.0

TID #: PMP4496

Orderable: N/A

Assembly Note ZZ1: These assemblies are ESD sensitive, ESD precautions shall be observed.

Assembly Note ZZ2: These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

Assembly Note ZZ3: These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Label Table

<table>
<thead>
<tr>
<th>Variant</th>
<th>Label Text</th>
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<tbody>
<tr>
<td>001</td>
<td>ChangeMe!</td>
</tr>
<tr>
<td>002</td>
<td>ChangeMe!</td>
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PCB
LOGO
Pb-Free Symbol

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